

AA-DUCT 2902 Pure Silver Filled Electrically Conductive Epoxy

AA-DUCT 2902 is a pure silver-filled, two-component epoxy adhesive designed for applications requiring maximum electrical conductivity and strong mechanical and thermal properties. This versatile formulation offers exceptional continuity of conductivity with a low electrical resistivity value of less than 1×10-4 ohm·cm. It is a solvent-free adhesive with excellent adhesion to a wide range of substrates and can be cured at room temperature or with heat for a faster bond.

This product is ideal for electronic bonding and sealing, including applications like **EMI/RFI shielding**, circuit repair, and bonding heat-sensitive components as a cold solder. Its robust performance is maintained over a wide operating temperature range from **–50 to +170°C**.

Product Properties

Property Value

Appearance Silver

Cure Type Room Temperature or Heat Cure

Mix Ratio (by weight) 100:6 (Resin:Hardener)

Substrates Aluminum, Copper, Magnesium, Steel, Bronze, Nickel, Kovar, Ceramic, Glass, Phenolic, G-10 Epoxy Glass Boards

Operating Temperature -50 to +170°C

Typical Applications Electrical, Conductive, EMI/RFI Shielding, Circuitry, Printed Circuit Board and Electronics Repair

Uncured Properties

Property Value

Specific Gravity (mixed) 2.79

Reactive Solids Content 100%

Pot Life 1 Hour

Shelf Life 6 months (Bi-pax), 1 year (Jars & Syringes)

Viscosity Paste (20,000 CPS)

Cure Schedule

Cure Time Temperature

15 minutes 100°C

1-4 hours 65°C

24 hours Room Temperature

Cured Properties

Property Value

Hardness (Shore D) 80

Lap Shear Strength 5 N/mm2 (700 psi)

Volume Resistivity \$< 0.0001 ohm·cm}

 $\textbf{Thermal Conductivity} \quad 2.99 \, \text{W/mK}$

Tensile Strength 9,500 psi

Compressive Strength 14,000 psi

NASA Outgassing Passed (TML: 0.64%, CVCM: 0.05%)

General Information

For safe handling, always consult the Material Safety Data Sheet (MSDS) for this product.

How to Use

- Preparation: Ensure all surfaces are thoroughly cleaned and dried before application.
- 2. Mixing: Some settling of components may occur during storage. Mix the contents of the container thoroughly before use to ensure a uniform consistency and optimal performance.
- 3. Application: Apply the fully mixed adhesive to the prepared surfaces and gently press them together. Light contact pressure is sufficient.
- 4. **Curing:** Maintain contact between the surfaces until the adhesive is fully cured according to the recommended cure schedule.
- 5. **Crystallization**: If the product is stored at low temperatures, crystallization may occur. Gentle warming at 52°C for 30 minutes can re-dissolve the components, restoring them to a liquid state for best results.